




Features

- Very low profile
- Very fast tripping time
- High voltage
- RoHS compliant*
- Symmetrical
- 2018 footprint
- Agency recognition:   

Applications

- Power Over Ethernet (IEEE 802.3 af) port protection
- Automotive electronic control module protection
- Telecom equipment low voltage protection

MF-SMDF Series - PTC Resettable Fuses

Electrical Characteristics

Model	V max. Volts	I max. Amps	I _{hold}	I _{trip}	Resistance		Max. Time To Trip		Tripped Power Dissipation
			Amperes at 23 °C		Ohms at 23 °C		Amperes at 23 °C	Seconds at 23 °C	Watts at 23 °C
			Hold	Trip	R _{Min.}	R _{1Max.}			Typ.
MF-SMDF050	60	10	0.55	1.20	0.200	1.0	2.5	3.0	1.0
MF-SMDF150*	15	40	1.5	3.00	0.7	0.17	8.0	0.8	1.1

*Agency approval pending.

Environmental Characteristics

Operating Temperature	-40 °C to +85 °C
Maximum Device Surface Temperature	
in Tripped State	125 °C
Passive Aging.....	+85 °C, 1000 hours±5 % typical resistance change
Humidity Aging.....	+85 °C, 85 % R.H. 1000 hours±5 % typical resistance change
Thermal Shock.....	+85 °C to -40 °C, 20 times±10 % typical resistance change
Solvent Resistance	MIL-STD-202, Method 215No change
Vibration	MIL-STD-883C, Method 2007.1,No change Condition A

Test Procedures And Requirements For Model MF-SMDF Series

Test	Test Conditions	Accept/Reject Criteria
Visual/Mech.....	Verify dimensions and materials	Per MF physical description
Resistance	In still air @ 23 °C.....	R _{min} ≤ R ≤ R _{1max}
Time to Trip	At specified current, V _{max} , 23 °C	T ≤ max. time to trip (seconds)
Hold Current	30 min. at I _{hold}	No trip
Trip Cycle Life	V _{max} , I _{max} , 100 cycles.....	No arcing or burning
Trip Endurance.....	V _{max} , 48 hours	No arcing or burning
Solderability	ANSI/J-STD-002	95 % min. coverage
UL File Number	E174545 http://www.ul.com/ Follow link to Certifications, then UL File No., enter E174545	
CSA File Number	CA110338 http://directories.csa-international.org/ Under "Certification Record" and "File Number" enter 110338-0-000	
TÜV Certificate Number	R 02057213 http://www.tuvdotcom.com/ Follow link to "other certificates", enter File No. 2057213	

Thermal Derating Chart - I_{hold} / I_{trip} (Amps)

Model	Ambient Operating Temperature								
	-40 °C	-20 °C	0 °C	23 °C	40 °C	50 °C	60 °C	70 °C	85 °C
MF-SMDF050	0.86 / 1.72	0.77 / 1.54	0.70 / 1.40	0.55 / 1.10	0.48 / 0.96	0.43 / 0.86	0.38 / 0.76	0.36 / 0.72	0.26 / 0.52
MF-SMDF150	2.38 / 4.76	2.10 / 4.20	1.82 / 3.64	1.50 / 3.00	1.27 / 2.54	1.13 / 2.26	0.99 / 1.98	0.85 / 1.70	0.64 / 1.28

*RoHS Directive 2002/95/EC Jan 27 2003 including Annex
Specifications are subject to change without notice.
Customers should verify actual device performance in their specific applications.

MF-SMDF Series - PTC Resettable Fuses

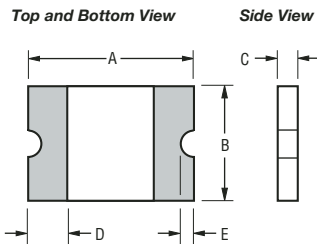
BOURNS®

Product Dimensions

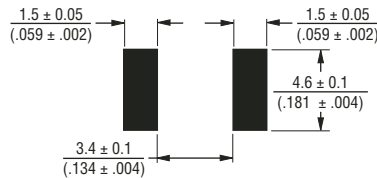
Model	A		B		C		D	E	
	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Min.	Max.
MF-SMDF050	$\frac{4.72}{(0.186)}$	$\frac{5.44}{(0.214)}$	$\frac{4.22}{(0.166)}$	$\frac{4.93}{(0.194)}$	$\frac{0.79}{(0.031)}$	$\frac{1.09}{(0.043)}$	$\frac{0.30}{(0.012)}$	$\frac{0.25}{(0.010)}$	$\frac{0.65}{(0.026)}$
MF-SMDF150	$\frac{4.72}{(0.186)}$	$\frac{5.44}{(0.214)}$	$\frac{4.22}{(0.166)}$	$\frac{4.93}{(0.194)}$	$\frac{0.55}{(0.022)}$	$\frac{0.85}{(0.033)}$	$\frac{0.30}{(0.012)}$	$\frac{0.25}{(0.010)}$	$\frac{0.65}{(0.026)}$

Packaging: 3000 pcs. per reel.

UNIT = $\frac{\text{MM}}{\text{(INCHES)}}$



Recommended Pad Layout



Terminal material:

Electroless Ni under immersion Au

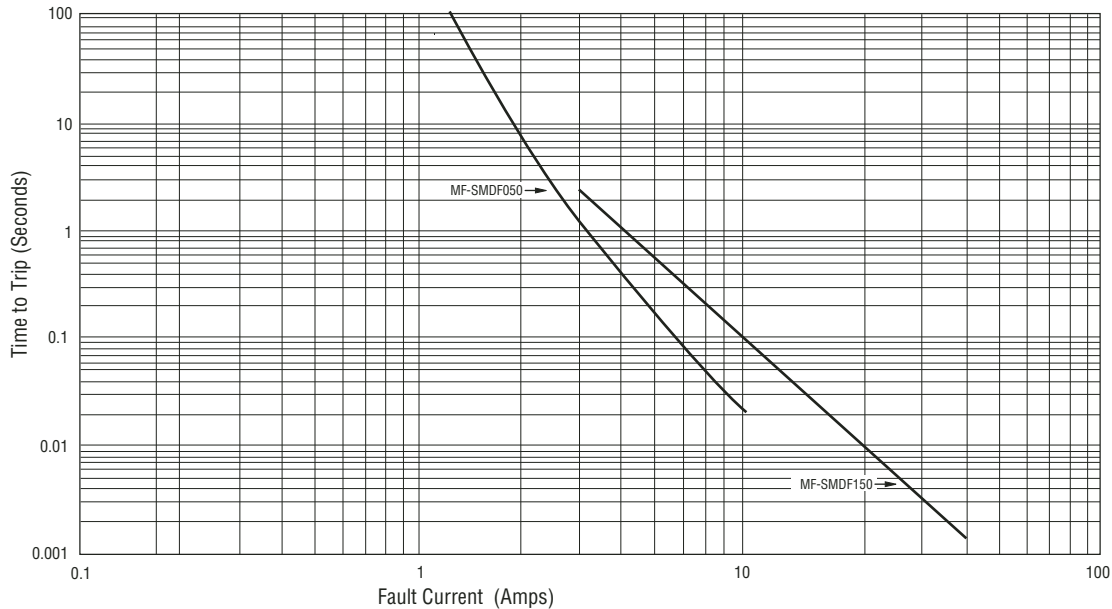
Termination pad solderability:

Standard Au finish:
Meets ANSI/J-STD-002 Category 2.

Recommended Storage:

40 °C max./70 % RH max.

Typical Time to Trip at 23 °C

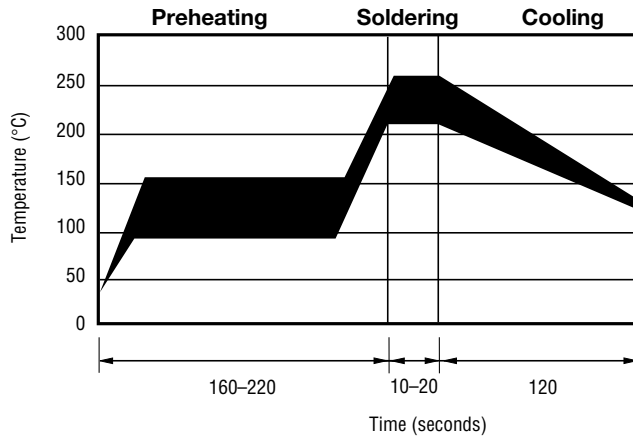


The Time to Trip curves represent typical performance of a device in a simulated application environment. Actual performance in specific customer applications may differ from these values due to the influence of other variables.

MF-SMDF Series - PTC Resettable Fuses

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Solder Reflow Recommendations



Notes:

- MF-SMDF models cannot be wave soldered. Please contact Bourns for hand soldering recommendations.
- If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.
- Compatible with Pb and Pb-free solder reflow profiles.

How to Order

MF - SMDF 050 - 2

Multifuse® Product Designator _____

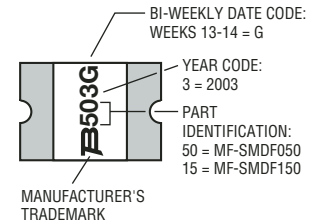
Series _____
 SMDF = 2018 Surface Mount Component

Hold Current, I_{hold} _____
 050, 150 (0.50 - 1.50 Amps)

Packaging _____
 Packaged per EIA 481-1
 -2 = Tape and Reel

Typical Part Marking

Represents total content. Layout may vary.



MF-SMDF Series Tape and Reel Specifications



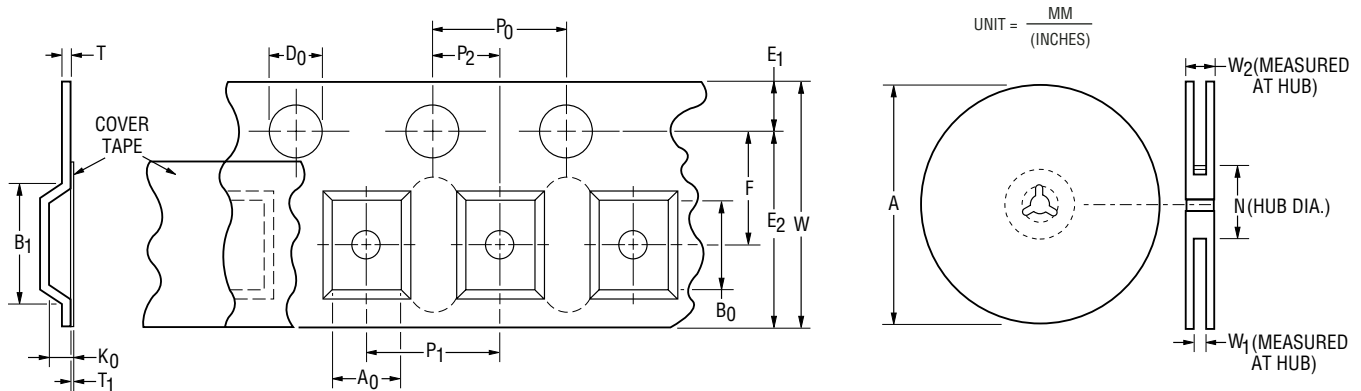
MF-SMDF Series per EIA 481-2

Tape Dimensions

W	$\frac{16.0 \pm 0.3}{(0.630 \pm 0.012)}$
P ₀	$\frac{4.0 \pm 0.1}{(0.157 \pm 0.004)}$
P ₁	$\frac{8.0 \pm 0.1}{(0.315 \pm 0.004)}$
P ₂	$\frac{2.0 \pm 0.1}{(0.079 \pm 0.004)}$
A ₀	$\frac{5.1 \pm 0.15}{(0.201 \pm 0.006)}$
B ₀	$\frac{5.6 \pm 0.23}{(0.220 \pm 0.009)}$
B ₁ max.	$\frac{12.1}{(0.476)}$
D ₀	$\frac{1.5 + 0.1/-0.0}{(0.059 + 0.004/-0)}$
F	$\frac{7.5 \pm 0.10}{(0.295 \pm 0.004)}$
E ₁	$\frac{1.75 \pm 0.10}{(0.069 \pm 0.004)}$
E ₂ min.	$\frac{14.25}{(0.561)}$
T max.	$\frac{0.6}{(0.024)}$
T ₁ max.	$\frac{0.1}{(0.004)}$
K ₀	$\frac{1.0 \pm 0.15}{(0.039 \pm 0.015)}$
Leader min.	$\frac{390}{(15.35)}$
Trailer min.	$\frac{160}{(6.30)}$

Reel Dimensions

A max.	$\frac{331}{(13.03)}$
N min.	$\frac{50}{(1.97)}$
W ₁	$\frac{16.4 + 2.0/-0.0}{(0.646 + 0.079/-0.0)}$
W ₂ max.	$\frac{22.4}{(0.882)}$



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